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Dated: July 28, 2004

Signature: Elena Parise

Elena Parise

IFW

Ref.: 7452-105/10313554  
(PATENT)



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Shih-Ping Hsu

Confirmation No.: 6002

Application No.: 10/695,356

Group Art Unit: 2812

Filed: October 27, 2003

Examiner: Berezny, Nema O.

For: SEMICONDUCTOR PACKAGE  
SUBSTRATE HAVING CONTACT PAD  
PROTECTIVE LAYER FORMED THEREON  
AND METHOD FOR FABRICATING THE  
SAME

**RESPONSE TO RESTRICTION REQUIREMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the requirement for restriction in the Office Action dated June 28, 2004, Applicant hereby elects with traverse Group II, claims 7-20, drawn to a method of making a semiconductor device.

**REMARKS**

Applicant elects Group II, claims 7-20, with traverse.


An early action on the merits is awaited

The Commissioner is hereby authorized to charge any fee which should have been

filed herewith to our Deposit Account No. 50-0337, under Order No. LA-7452-105/10313554. A duplicate copy of this paper is enclosed.

Dated: July 28, 2004

Respectfully submitted,

By   
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